

OSFP28 HOST CONNECTOR

The enhanced QSFP+ (eQSFP+) connector and mechanical kit is supports data rates up to 56Gbps per channel. All products are designed in accordance with the Multi-Source Agreement (MSA).



Series No. of Contacts 0 - Style B Contact Plating 1 - 0.76 µm Au

2 - 0.40 µm Au

SPECIFICATIONS

Operating Temp. Range: - 20° to 85° C Durability: 100 cycles

Plug in Force: 55 N max. with Heatsink
Pull-out Force: 45 N max. with Heatsink

Press fit insertion force: 140 N min. Test Standard: EIA-364

MATERIALS AND FINISH

Contact: Copper Alloy
Contact area: Ni-Au
Soldering area: Sn
Insulator: LCP

FEATURES.

- . High speed up to 28Gbps (NRZ) 56Gbps (PAM4)
- Pitch: 0.8 mm
- · Pin Count: 38 Pins
- Compatible with existing QSFP (Infiniband: QDR / FDR / EDR) module
- · Fully compatible foot pattern with existing QSFP connector
- RoHS2011/65/EU
- · REACH conform according to EU Regulation 1907/2006

STYLE DEFINITION

Style	SFF Spec.	Peg to Row B
В	SFF 8672	7.69

OUTLINE DIMENSIONS CN120 - 038 -0 00 *



